

November 2013

FQPF16N15

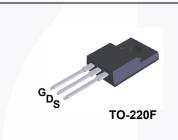
N-Channel QFET[®] MOSFET 150 V, 11.6 A, 160 m Ω

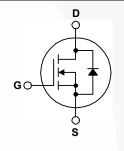
Description

This N-Channel enhancement mode power MOSFET is produced using Fairchild Semiconductor's proprietary planar stripe and DMOS technology. This advanced MOSFET technology has been especially tailored to reduce on-state resistance, and to provide superior switching performance and high avalanche energy strength. These devices are suitable for switched mode power supplies, audio amplifier, DC motor control, and variable switching power applications.

Features

- 11.6 A, 150 V, $R_{DS(on)}$ = 160 m Ω (Max.) @ V_{GS} = 10 V, I_D = 5.8 A
- Low Gate Charge (Typ. 23 nC)
- Low Crss (Typ. 30 pF)
- 100% Avalanche Tested
- 175°C Maximum Junction Temperature Rating





Absolute Maximum Ratings T_c = 25°C unless otherwise noted

Symbol	Parameter	FQPF16N15	Unit V
V _{DSS}	Drain-Source Voltage	150	
I _D	Drain Current - Continuous (T _C = 25°C)	11.6	Α
	- Continuous (T _C = 100°C)	8.2	Α
I _{DM}	Drain Current - Pulsed (Note 1)	46.4	Α
V _{GSS}	Gate-Source Voltage	± 25	V
E _{AS}	Single Pulsed Avalanche Energy (Note 2)	230	mJ
I _{AR}	Avalanche Current (Note 1)	11.6	Α
E _{AR}	Repetitive Avalanche Energy (Note 1)	5.3	mJ
dv/dt	Peak Diode Recovery dv/dt (Note 3)	6.0	V/ns
PD	Power Dissipation ($T_C = 25^{\circ}C$)		W
	- Derate Above 25°C	0.36	W/°C
T _J , T _{STG}	Operating and Storage Temperature Range	-55 to +175	°C
ΤL	Maximum Lead Temperature for Soldering, 1/8" from Case for 5 seconds	300	°C

Thermal Characteristics

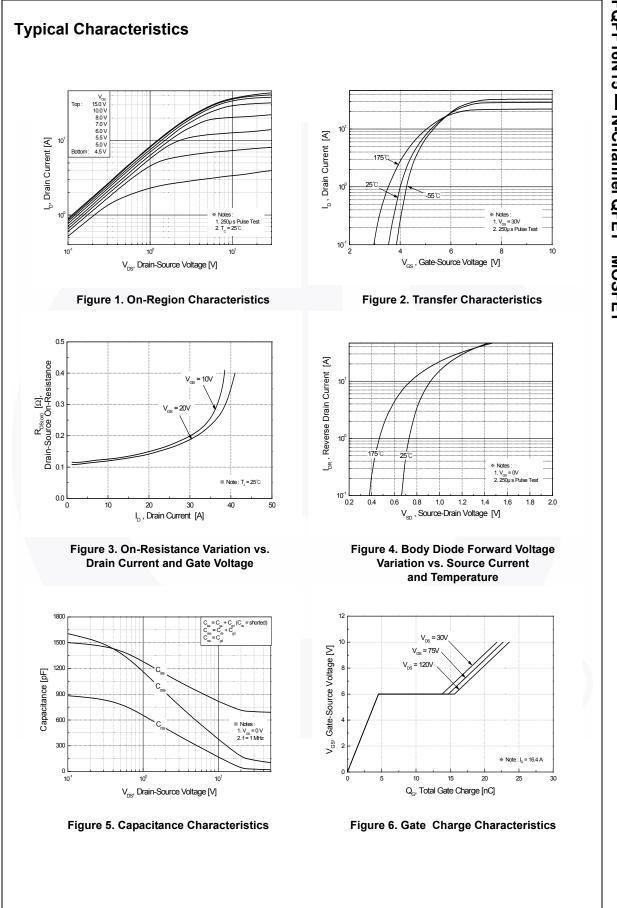
Symbol	Parameter	FQPF16N15	Unit	
$R_{ extsf{ heta}JC}$	Thermal Resistance, Junction-to-Case, Max.	2.78	°C/W	
$R_{ extsf{ heta}JA}$	Thermal Resistance, Junction-to-Ambient, Max.	62.5	C/W	

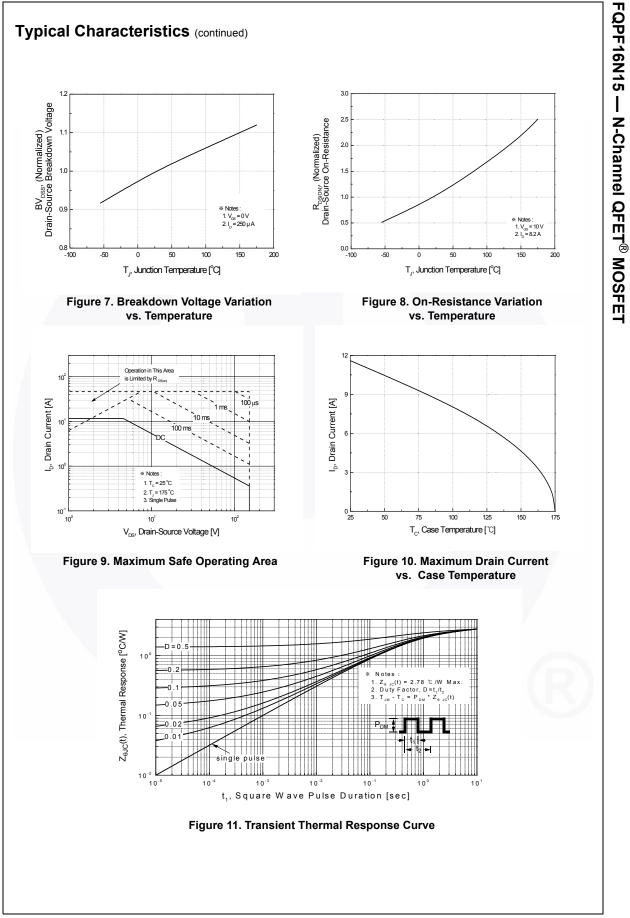
Part Nu	Part NumberTop MarkPackageFQPF16N15FQPF16N15TO-220F		Package	Packing Method Reel Size		Tape Width		Quantity	
FQPF1			Tube N/A		N/A		50 units		
lectri	cal C	haracteristics	T _C = 25°C	unless otherwise noted.					
Symbol		Parameter		Test Condit	ions	Min.	Тур.	Max.	Unit
Off Ch	aracto	ristics							
BV _{DSS}	aracteristics Drain-Source Breakdown Voltage		oltage	V _{GS} = 0 V, I _D = 250 μA		150			V
ABV _{DSS}			0			100			v
ΔT_{J}	Breakdown Voltage Temperature Coefficient		alure	I_D = 250 μ A, Referenced to 25°C			0.17		V/°C
DSS	Zero Gate Voltage Drain Current		rront	V _{DS} = 150 V, V _{GS} = 0 V				1	μA
			Irrent	V _{DS} = 120 V, T _C = 150°C				10	μA
GSSF	Gate-	Body Leakage Currer	nt, Forward	V _{GS} = 25 V, V _{DS} = 0 V				100	nA
GSSR	Gate-I	Body Leakage Currer	nt, Reverse	V_{GS} = -25 V, V_{DS} = 0	V			-100	nA
		inting							
V _{GS(th)}	aracteristics Gate Threshold Voltage		V _{DS} = V _{GS} , I _D = 250 μA		2.0		4.0	V	
R _{DS(on)}		Static Drain-Source On-Resistance		$V_{GS} = 10 \text{ V}, \text{ I}_{D} = 5.8 \text{ A}$		2.0	0.12	4.0	v
-DS(0II)							3	0.16	Ω
FS	Forward Transconductance			V_{DS} = 40 V, I _D = 5.8	A		8.3		S
D	ia Cha	ve ete vietie e							
Dynam C _{iss}	1	Tracteristics					700	910	pF
Soss				$V_{DS} = 25 V, V_{GS} = 0 V,$			145	190	pF
Crss		Output Capacitance Reverse Transfer Capacitance		f = 1.0 MHz			30	40	pF
-155	1.070		100					10	p.
		aracteristics							
d(on)		On Delay Time		V _{DD} = 75 V, I _D = 16.4 A,			11	30	ns
r		On Rise Time		R _G = 25 Ω	-		115	240	ns
d(off)		Off Delay Time			(Note 4)		50	110	ns
f		Off Fall Time		(Note 4)			80	170	ns
2 _g		Gate Charge		V_{DS} = 120 V, I _D = 16.4 A, V_{GS} = 10 V (Note 4)			23	30	nC
2 _{gs}		Source Charge					4.5		nC
ຊ _{gd}	Gate-L	Drain Charge					11		nC
Drain_9	Sourco	Diodo Charact	vrietice an	d Maximum Rati	inge				
	-	um Continuous Drair			iiys			11.6	Δ
S		num Pulsed Drain-So						46.4	A
sм / _{SD}		Source Diode Forwar	r					1.5	A V
r SD		se Recovery Time	u voliage	$V_{GS} = 0 V, I_S = 11.6 A$ $V_{GS} = 0 V, I_S = 16.4 A,$			 85	_	
տ Չո		se Recovery Time		$V_{GS} = 0 V, I_S = 16.4 A,$ dI _F / dt = 100 A/µs			0.35		ns μC

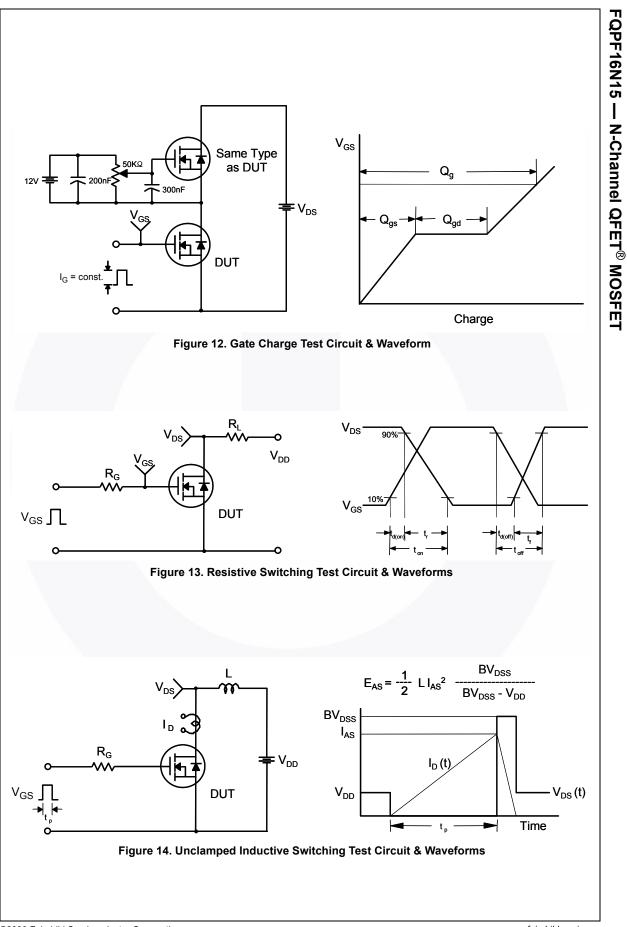
 $\begin{array}{l} 2. \ L=2.85 \ \text{mH}, \ I_{AS}=11.6 \ \text{A}, \ V_{DD}=25 \ \text{V}, \ \text{R}_{G}=25 \ \Omega, \ \text{starting} \ \ \text{T}_{J}=25^{\circ}\text{C}. \\ 3. \ I_{SD}\leq11.6 \ \text{A}, \ \text{di/dt}\leq300 \ \text{A/}\mu\text{s}, \ \text{V}_{DD}\leq8V_{DSS}, \ \text{starting} \ \ \text{T}_{J}=25^{\circ}\text{C}. \end{array}$

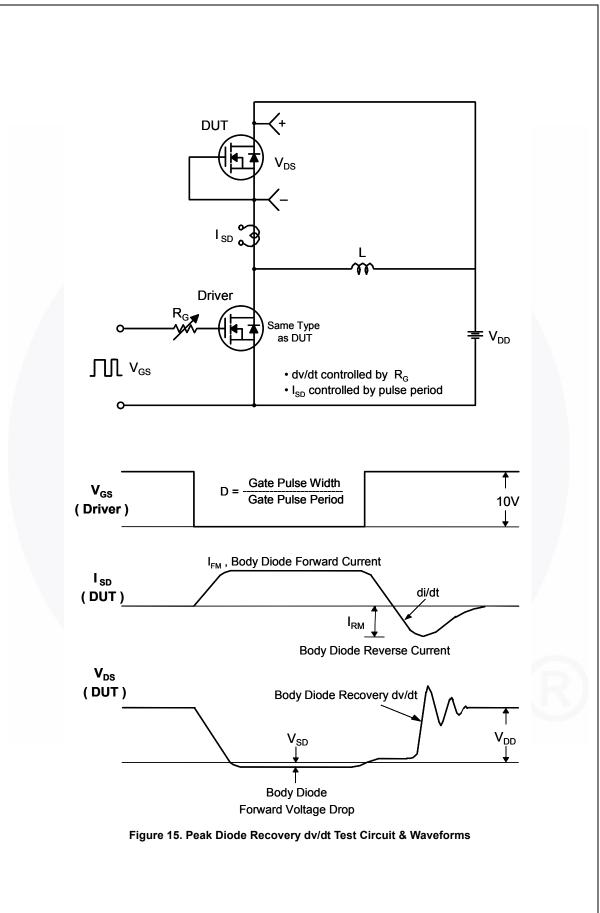
4. Essentially independent of operating temperature.

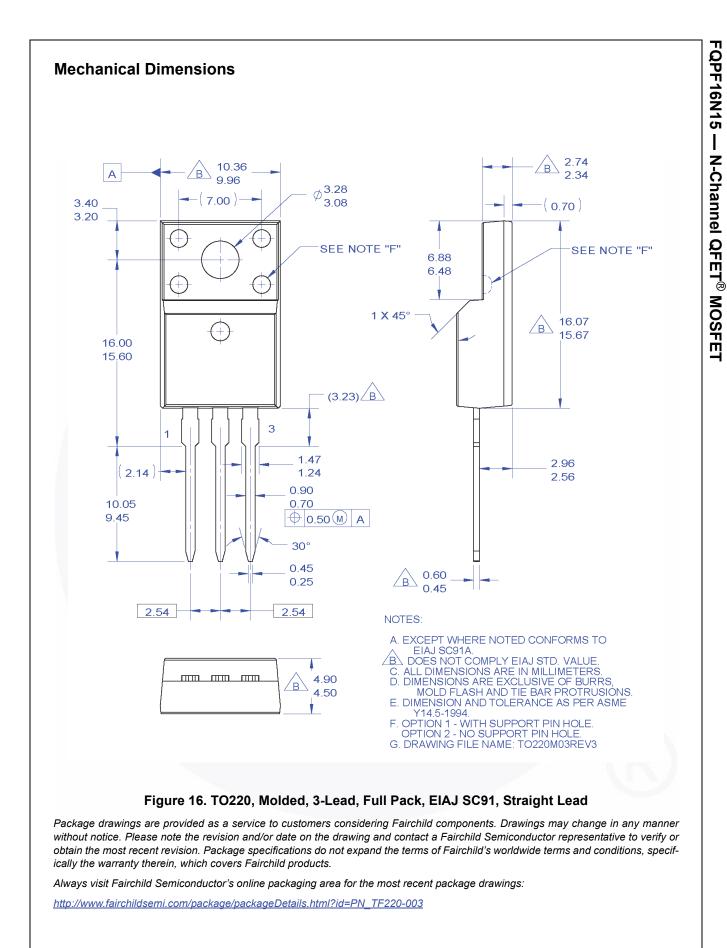
FQPF16N15 — N-Channel QFET[®] MOSFET













SEMICONDUCTOR

TRADEMARKS

The following includes registered and unregistered trademarks and service marks, owned by Fairchild Semiconductor and/or its global subsidiaries, and is not intended to be an exhaustive list of all such trademarks.

AccuPower™	F-PFS™
AX-CAP [®] *	FRFET®
BitSiC™	Global Power Resource SM
Build it Now™	GreenBridge™
CorePLUS™	Green FPS™
CorePOWER™	Green FPS™ e-Series™
CROSSVOLT™	G <i>ma</i> x™
CTL™	GTO™
Current Transfer Logic™	IntelliMAX™
	ISOPLANAR™
Dual Cool™_	Marking Small Speakers S
EcoSPARK [®]	and Better™
EfficentMax™	MegaBuck™
ESBC™	MICROCOUPLER™
R	MicroFET™
F	MicroPak™
Fairchild®	MicroPak2™
	Miller Drive M

Fairchild Semiconductor® FACT Quiet Series™ FACT® FAST® FastvCore™ FETBench™ FPS™

ge™ ™ e-Series™ M R™ nall Speakers Sound Louder тм UPLER™ тм MillerDrive™ MotionMax™ mWSaver® OptoHiT™ **OPTOLOGIC® OPTOPLANAR[®]**

 $(1)_{\mathbb{B}}$ PowerTrench® PowerXS™ Programmable Active Droop™ QFET QS™ Quiet Series™ RapidConfigure™ Saving our world, 1mW/W/kW at a time™ SignalWise™ SmartMax™ SMART START™ Solutions for Your Success™ SPM[®] STEALTH™ SuperFET[®] SuperSOT™-3 SuperSOT™-6 SuperSOT™-8

ESYSTEM^{®*} GENERAL TinyBoost TinyBuck® TinyCalc™ TinyLogic® TINYOPTO™ TinvPower™ TinyPWM™ TinyWire™ TranSiC™ TriFault Detect™ TRUECURRENT®* uSerDes™ UHC® Ultra FRFET™ UniFFT™ VCX™

VisualMax™

XS™

VoltagePlus™

Sync-Lock™

FQPF16N15

I

N-Channel QFET[®] MOSFET

*Trademarks of System General Corporation, used under license by Fairchild Semiconductor.

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION, OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS. THESE SPECIFICATIONS DO NOT EXPAND THE TERMS OF FAIRCHILD'S WORLDWIDE TERMS AND CONDITIONS, SPECIFICALLY THE WARRANTY THEREIN, WHICH COVERS THESE PRODUCTS.

SupreMOS®

SvncFET™

LIFE SUPPORT POLICY FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION.

As used here in:

- Life support devices or systems are devices or systems which, (a) are 1. intended for surgical implant into the body or (b) support or sustain life, and (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in a significant injury of the user.
- 2. A critical component in any component of a life support, device, or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

ANTI-COUNTERFEITING POLICY

Fairchild Semiconductor Corporation's Anti-Counterfeiting Policy. Fairchild's Anti-Counterfeiting Policy is also stated on our external website, www.Fairchildsemi.com, under Sales Support.

Counterfeiting of semiconductor parts is a growing problem in the industry. All manufactures of semiconductor products are experiencing counterfeiting of their parts. Customers who inadvertently purchase counterfeit parts experience many problems such as loss of brand reputation, substandard performance, failed application, and increased cost of production and manufacturing delays. Fairchild is taking strong measures to protect ourselves and our customers from the proliferation of counterfeit parts. Fairchild strongly encourages customers to purchase Fairchild parts either directly from Fairchild or from Authorized Fairchild Distributors who are listed by country on our web page cited above. Products customers buy either from Fairchild directly or from Authorized Fairchild Distributors are genuine parts, have full traceability, meet Fairchild's quality standards for handing and storage and provide access to Fairchild's full range of up-to-date technical and product information. Fairchild and our Authorized Distributors will stand behind all warranties and will appropriately address and warranty issues that may arise. Fairchild will not provide any warranty coverage or other assistance for parts bought from Unauthorized Sources. Fairchild is committed to combat this global problem and encourage our customers to do their part in stopping this practice by buying direct or from authorized distributors.

PRODUCT STATUS DEFINITIONS Definition of Tern

Datasheet Identification	Product Status	Definition		
Advance Information	Formative / In Design	Datasheet contains the design specifications for product development. Specifications may change in any manner without notice.		
Preliminary	First Production	Datasheet contains preliminary data; supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve design.		
No Identification Needed	Full Production	Datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice to improve the design.		
Obsolete	Not In Production	Datasheet contains specifications on a product that is discontinued by Fairchild Semiconductor. The datasheet is for reference information only.		

Mouser Electronics

Authorized Distributor

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

Fairchild Semiconductor: